

2SB1002

Silicon PNP Epitaxial

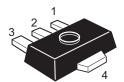
REJ03G0660-0200 (Previous ADE-208-1035) Rev.2.00 Aug.10.2005

Application

- Low frequency power amplifier
- Complementary pair with 2SD1368

Outline

RENESAS Package code: PLZZ0004CA-A (Package name: UPAK $^{\circledR}$)



- 1. Base
- 2. Collector
- 3. Emitter
- 4. Collector (Flange)

*UPAK is a trademark of Renesas Technology Corp.

Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Symbol Ratings	
Collector to base voltage	V _{CBO}	-70	V
Collector to emitter voltage	V _{CEO}	-50	V
Emitter to base voltage	V _{EBO}	-6	V
Collector current	I _C	-1	А
Collector peak current	i _{C(peak)} * ¹	-1.5	А
Collector power dissipation	Pc*2	1	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW ≤ 10 ms, Duty cycle ≤ 20%

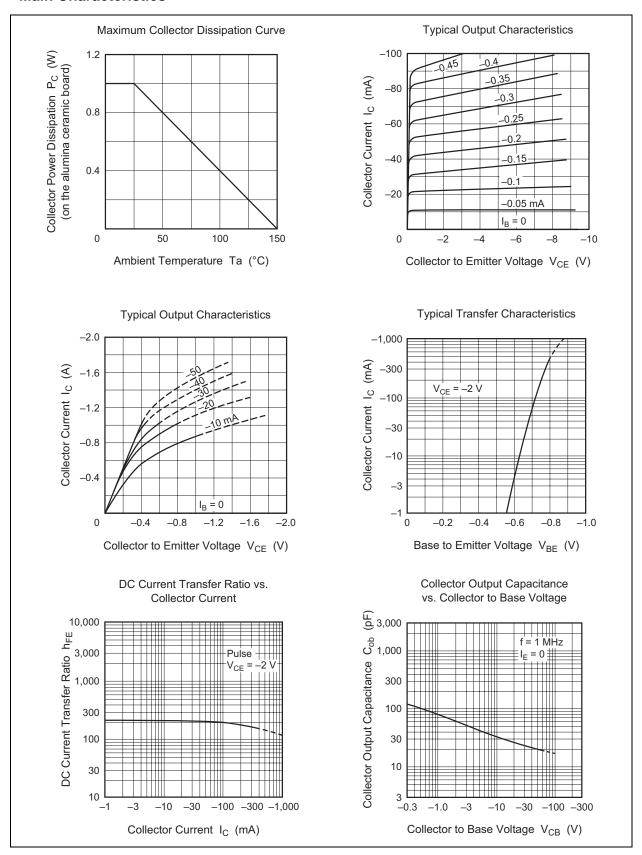
2. Value on the alumina ceramic board (12.5 \times 20 \times 0.7 mm)

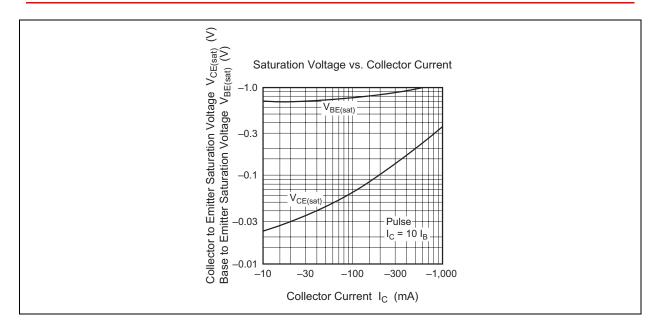
Electrical Characteristics

 $(Ta = 25^{\circ}C)$

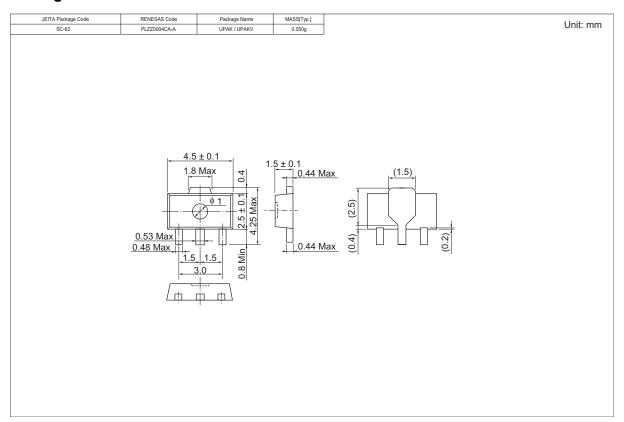
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	-70	_	_	V	$I_C = -10 \mu A, I_E = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	-50	_	_	V	$I_C = -1 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	-6	_	_	V	$I_E = -10 \mu\text{A}, I_C = 0$
Collector cutoff current	I _{CBO}	_	_	-0.1	μΑ	$V_{CB} = -50 \text{ V}, I_E = 0$
Emitter cutoff current	I _{EBO}	_	_	-0.1	μΑ	$V_{EB} = -4 \text{ V}, I_C = 0$
DC current transfer ratio	h _{FE}	160	_	320		$V_{CE} = -2 \text{ V}, I_{C} = -0.1 \text{ A}$
Collector to emitter saturation voltage	V _{CE(sat)}	_	_	-0.6	V	$I_C = -1 A$,
						$I_B = -0.1 \text{ A (Pulse test)}$
Base to emitter saturation voltage	V _{BE(sat)}	_	_	-1.2	V	$I_C = -1 A$,
						$I_B = -0.1 \text{ A (Pulse test)}$
Gain bandwidth product	f _T	_	150	_	MHz	$V_{CE} = -2 V$,
						$I_C = -10 \text{ mA (Pulse test)}$
Collector output capacitance	Cob	_	35	_	pF	$V_{CB} = -10 \text{ V}, I_E = 0,$
						f = 1 MHz

Main Characteristics





Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SB1002CJTL-E	1000	φ 178 mm Reel, 12 mm Emboss Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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